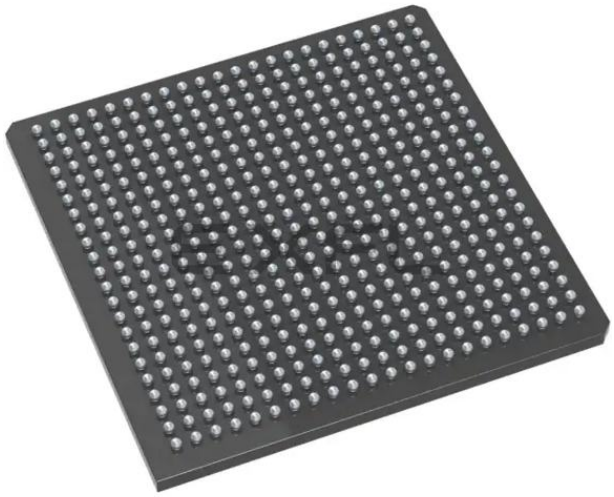

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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Active
Number of LABs/CLBs	18144
Number of Logic Elements/Cells	-
Total RAM Bits	165888
Number of I/O	317
Number of Gates	1000000
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 70°C (TA)
Package / Case	484-BGA
Supplier Device Package	484-FPBGA (23x23)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/ax1000-1fg484

The SRAM blocks are arranged in a column on the west side of the tile (Figure 1-6 on page 1-4).

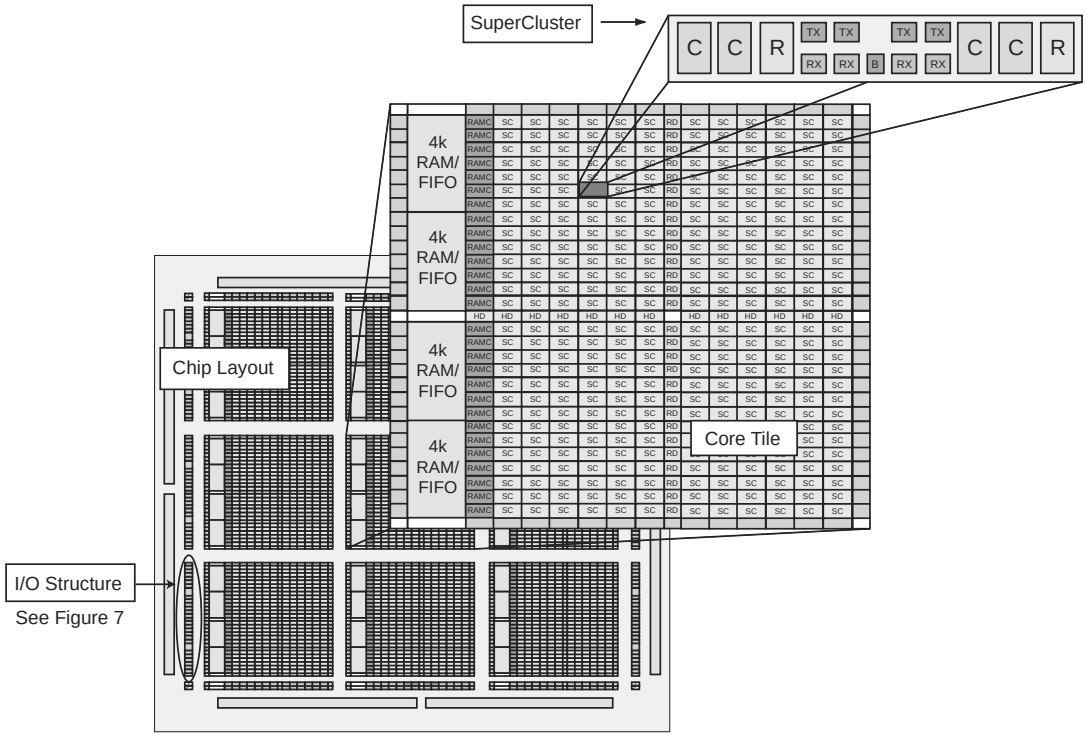


Figure 1-6 AX Device Architecture (AX1000 shown)

Embedded Memory

As mentioned earlier, each core tile has either three (in a smaller tile) or four (in the regular tile) embedded SRAM blocks along the west side, and each variable-aspect-ratio SRAM block is 4,608 bits in size. Available memory configurations are: 128x36, 256x18, 512x9, 1kx4, 2kx2 or 4kx1 bits. The individual blocks have separate read and write ports that can be configured with different bit widths on each port. For example, data can be written in by eight and read out by one.

In addition, every SRAM block has an embedded FIFO control unit. The control unit allows the SRAM block to be configured as a synchronous FIFO without using core logic modules. The FIFO width and depth are programmable. The FIFO also features programmable ALMOST-EMPTY (AEMPTY) and ALMOST-FULL (AFULL) flags in addition to the normal EMPTY and FULL flags. In addition to the flag logic, the embedded FIFO control unit also contains the counters necessary for the generation of the read and write address pointers as well as control circuitry to prevent metastability and erroneous operation. The embedded SRAM/FIFO blocks can be cascaded to create larger configurations.

I/O Logic

The Axcelerator family of FPGAs features a flexible I/O structure, supporting a range of mixed voltages with its bank-selectable I/Os: 1.5V, 1.8V, 2.5V, and 3.3V. In all, Axcelerator FPGAs support at least 14 different I/O standards (single-ended, differential, voltage-referenced). The I/Os are organized into banks, with eight banks per device (two per side). The configuration of these banks determines the I/O standards supported (see "User I/Os" on page 2-11 for more information). All I/O standards are available in each bank.

Each I/O module has an input register (InReg), an output register (OutReg), and an enable register (EnReg) (Figure 1-7 on page 1-5). An I/O Cluster includes two I/O modules, four RX modules, two TX modules, and a buffer (B) module.

Table 2-5 Different Components Contributing to the To tal Power Consumption in Axcelerator Devices

Component	Definition	Device Specific Value (in µW/MHz)				
		AX125	AX250	AX500	AX1000	AX2000
P1	Core tile HCLK power component	33	49	71	130	216
P2	R-cell power component	0.2	0.2	0.2	0.2	0.2
P3	HCLK signal power dissipation	4.5	4.5	9	13.5	18
P4	Core tile RCLK power component	33	49	71	130	216
P5	R-cell power component	0.3	0.3	0.3	0.3	0.3
P6	RCLK signal power dissipation	6.5	6.5	13	19.5	26
P7	Power dissipation due to the switching activity on the R-cell	1.6	1.6	1.6	1.6	1.6
P8	Power dissipation due to the switching activity on the C-cell	1.4	1.4	1.4	1.4	1.4
P9	Power component associated with the input voltage	10	10	10	10	10
P10	Power component associated with the output voltage	See table Per pin contribution				
P11	Power component associated with the read operation in the RAM block	25	25	25	25	25
P12	Power component associated with the write operation in the RAM block	30	30	30	30	30
P13	Core PLL power component	1.5	1.5	1.5	1.5	1.5

Ptotal = Pdc + Pac

P_{dc} = ICCA * VCCA

P_{ac} = $P_{HCLK} + P_{CLK} + P_{R\text{-}cells} + P_{C\text{-}cells} + P_{inputs} + P_{outputs} + P_{memory} + P_{PLL}$

P_{HCLK} = (P1 + P2 * s + P3 * sqrt[s]) * Fs

s = the number of R-cells clocked by this clock

Fs = the clock frequency

PCLK = (P4 + P5 * s + P6 * sqrt[s]) * Fs

s = the number of R-cells clocked by this clock

Fs = the clock frequency

PR-cells = P7 * ms * Fs

ms = the number of R-cells switching at each Fs cycle

Fs = the clock frequency

PC-cells = P8 * mc * Fs

mc = the number of C-cells switching at each Fs cycle

Fs = the clock frequency

Pinputs = P9 * pi * Fpi

pi = the number of inputs

F_{pi} = the average input frequency

I/O Specifications

Pin Descriptions

Supply Pins

GND Ground

Low supply voltage.

VCCA Supply Voltage

Supply voltage for array (1.5V). See "Operating Conditions" on page 2-1 for more information.

VCCIBx Supply Voltage

Supply voltage for I/Os. Bx is the I/O Bank ID 0 to 7. See "Operating Conditions" on page 2-1 for more information.

VCCDA Supply Voltage

Supply voltage for the I/O differential amplifier and JTAG and probe interfaces. See "Operating Conditions" on page 2-1 for more information. VCCDA should be tied to 3.3V.

VCCPLA/B/C/D/E/F/G/H Supply Voltage

PLL analog power supply (1.5V) for internal PLL. There are eight in each device. VCCPLA supports the PLL associated with global resource HCLKA, VCCPLB supports the PLL associated with global resource HCLKB, etc. The PLL analog power supply pins should be connected to 1.5V whether PLL is used or not.

VCOMPLA/B/C/D/E/F/ G/H Supply Voltage

Compensation reference signals for internal PLL. There are eight in each device. VCOMPLA supports the PLL associated with global resource HCLKA, VCOMPLE supports the PLL associated with global resource CLKE, etc. (see Figure 2-2 on page 2-9 for correct external connection to the supply). The VCOMPLX pins should be left floating if PLL is not used.

VPUMP Supply Voltag e (External Pump)

In the low power mode, VPUMP will be used to access an external charge pump (if the user desires to bypass the internal charge pump to further reduce power). The device starts using the external charge pump when the voltage level on VPUMP reaches VIH[1]. In normal device operation, when using the internal charge pump, VPUMP should be tied to GND.

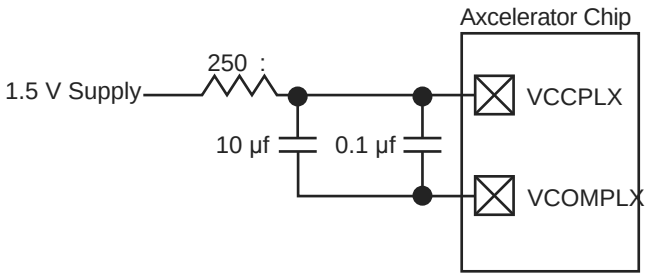


Figure 2-2 VCCPLX and VCOMPLX Po wer Supply Connect

1. When $V_{PUMP} = V_{IH}$, it shuts off the internal charge pump. See "Low Power Mode" on page 2-106 .

1.8 V LVCMOS

Low-Voltage Complementary Metal-Oxide Semiconductor for 1.8 V is an extension of the LVCMOS standard (JESD8-5) used for general-purpose 1.8 V applications. It uses a 3.3 V tolerant CMOS input buffer and a push-pull output buffer.

Table 2-26 DC Input and Output Levels

VIL		VIH		VOL	VOH	IOL	IOH
Min., V	Max., V	Min., V	Max., V	Max., V	Min., V	mA	mA
0.3	0.2 VCCI	0.7 VCCI	3.6	0.2	VCCI 0.2	8 mA	8 mA

AC Loadings

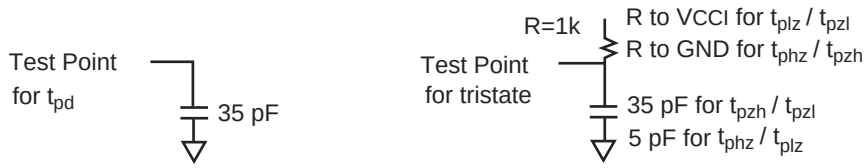


Figure 2-17 AC Test Loads

Table 2-27 AC Waveforms, Measuring Points, and Capacitive Loads

Input Low (V)	Input High (V)	Measu ring Point* (V)	VREF (typ) (V)	C_{load} (pF)
0	1.8	0.5 VCCI	N/A	35

Note: * Measuring Point = VTRIP

Table 2-72 AX500 Dedicated (Hardwired) Array Clock Networks
Worst-Case Commercial Conditions VCCA = 1.425 V, VCCI = 3.0 V, T_J = 70°C

		2 Speed		1 Speed		Std Speed		
Parameter	Description	Min.	Max.	Min.	Max.	Min.	Max.	Units
Dedicated (Hardwired) Array Clock Networks								
t_{HCKL}	Input Low to High		2.35		2.68		3.15	ns
t_{HCKH}	Input High to Low		2.44		2.79		3.27	ns
t_{HPWH}	Minimum Pulse Width High	0.58		0.65		0.77		ns
t_{HPWL}	Minimum Pulse Width Low	0.52		0.59		0.69		ns
t_{HCKSW}	Maximum Skew		0.06		0.07		0.08	ns
t_{HP}	Minimum Period	1.15		1.31		1.54		ns
t_{HMAX}	Maximum Frequency		870		763		649	MHz

Table 2-73 AX1000 Dedicated (Hardwired) Array Clock Networks
Worst-Case Commercial Conditions VCCA = 1.425 V, VCCI = 3.0 V, T_J = 70°C

		2 Speed		1 Speed		Std Speed		
Parameter	Description	Min.	Max.	Min.	Max.	Min.	Max.	Units
Dedicated (Hardwired) Array Clock Networks								
t_{HCKL}	Input Low to High		3.02		3.44		4.05	ns
t_{HCKH}	Input High to Low		3.03		3.46		4.06	ns
t_{HPWH}	Minimum Pulse Width High	0.58		0.65		0.77		ns
t_{HPWL}	Minimum Pulse Width Low	0.52		0.59		0.69		ns
t_{HCKSW}	Maximum Skew		0.06		0.07		0.08	ns
t_{HP}	Minimum Period	1.15		1.31		1.54		ns
t_{HMAX}	Maximum Frequency		870		763		649	MHz

Table 2-74 AX2000 Dedicated (Hardwired) Array Clock Networks
Worst-Case Commercial Conditions VCCA = 1.425 V, VCCI = 3.0 V, T_J = 70°C

		2 Speed		1 Speed		Std Speed		
Parameter	Description	Min.	Max.	Min.	Max.	Min.	Max.	Units
Dedicated (Hardwired) Array Clock Networks								
t_{HCKL}	Input Low to High		3.02		3.44		4.05	ns
t_{HCKH}	Input High to Low		3.03		3.46		4.06	ns
t_{HPWH}	Minimum Pulse Width High	0.58		0.65		0.77		ns
t_{HPWL}	Minimum Pulse Width Low	0.52		0.59		0.69		ns
t_{HCKSW}	Maximum Skew		0.06		0.07		0.08	ns
t_{HP}	Minimum Period	1.15		1.31		1.54		ns
t_{HMAX}	Maximum Frequency		870		763		649	MHz

CLK1 and CLK2

Both PLL outputs, CLK1 and CLK2, can be used to drive a global resource, an adjacent PLL RefCLK input, or a net in the FPGA core. Not all drive combinations are possible (Table 2-81).

Table 2-81 PLL General Connections Rules

CLK1	CLK2
HCLK	HCLK
CLK	CLK
HCLK	Routed net output
Routed net output	HCLK
HCLK	NONE
NONE	HCLK
CLK	NONE
NONE	CLK

Note: The PLL outputs remain Low when REFCLK is constant (either Low or High).

Restrictions on CLK1 and CLK2

When both are driving global resources, they must be driving the same type of global resource (i.e. either HCLK or CLK).

Only one can drive a routed net at any given time.

Table 2-82 and Table 2-83 specify all the possible CLK1 and CLK2 connections for the north and south PLLs. HCLK1 and HCLK2 are used to denote the different HCLK networks when two are being driven at the same time by a single PLL (Note that HCLK1 is the primary clock resource associated with the PLL, and HCLK2 is the clock resource associated with the adjacent PLL). Likewise, CLK1 and CLK2 are used to denote the different CLK networks when two are being driven at the same time by a single PLL (Figure 2-48 on page 2-75).

Table 2-82 North PLL Connections

CLK1	CLK2
HCLK1	Routed net
HCLK1	Unused
HCLK2	HCLK1
HCLK2	Routed net
HCLK2	Both HCLK1 and routed net
HCLK2	Unused
Unused	HCLK1
Unused	Routed net
Unused	Both HCLK1 and routed net
Unused	Unused
Routed net	HCLK1
Routed net	Unused
Both HCLK1 and HCLK2	Routed net
Both HCLK1 and HCLK2	Unused
Both HCLK1 and routed net	Unusable
Both HCLK2 and routed net	HCLK1
Both HCLK2 and routed net	Unused
HCLK1, HCLK2, and routed net	Unusable

Note: Designer software currently does not support all of these connections. Only exclusive connections where one output connects to a single net are supported at this time (e.g.CLK1 driving HCLK1, and HCLK2 is not supported).

Special PLL Macros

Table 2-84 shows the macros used to connect the RefCLK input and CLK1 and CLK2 outputs using the different routing resources.

Table 2-84 PLL Special Macros

Macro Name	Usage
PLLINT	Connects RefCLK to a regular routed net or a pad.
PLLRCLK	Connects CLK1 or CLK2 to the CLK network.
PLLHCLK	Connects CLK1 or CLK2 to the HCLK network.
PLLOUT	Connects CLK1 or CLK2 to a regular routed net.

Table 2-85 Electrical Specifications

Parameter	Value	Notes
Frequency Ranges		
Reference Frequency (min.)	14 MHz	Lowest input frequency
Reference Frequency (max.)	200 MHz	Highest input frequency
OSC Frequency (min.)	20 MHz	Lowest output frequency
OSC Frequency (max.)	1 GHz	Highest output frequency
Jitter		
Long-Term Jitter (max.)	1%	Percentage of period, low reference clock frequencies
Long-Term Jitter (max.)	100ps	High reference clock frequencies
Short-Term Jitter (max.)	50ps+1%	Percentage of output frequency
Acquisition Time (lock) from Cold Start		
Acquisition Time (max.)*	400 cycles	Period of low reference clock frequencies
Acquisition Time (max.)*	1.5 µs	High reference clock frequencies
Power Consumption		
Analog Supply Current (low freq.)	200 µA	Current at minimum oscillator frequency
Analog Supply Current (high freq.)	200 µA	Frequency-dependent current
Digital Supply Current (low freq.)	0.5 µA/MHz	Current at maximum oscillator frequency, unloaded
Digital Supply Current (high freq.)	1 µA/MHz	Frequency-dependent current
Duty Cycle		
Minimum Output Duty Cycle	45%	
Maximum Output Duty Cycle	55%	

Note: *The lock bit remains Low until RefCLK reaches the minimum input frequency.

Embedded Memory

The AX architecture provides extensive, high-speed memory resources to the user. Each 4,608 bit block of RAM contains its own embedded FIFO controller, allowing the user to configure each block as either RAM or FIFO.

To meet the needs of high performance designs, the memory blocks operate in synchronous mode for both read and write operations. However, the read and write clocks are completely independent, and each may operate up to and above 500 MHz.

No additional core logic resources are required to cascade the address and data buses when cascading different RAM blocks. Dedicated routing runs along each column of RAM to facilitate cascading.

The AX memory block includes dedicated FIFO control logic to generate internal addresses and external flag logic (FULL, EMPTY, AFULL, AEMPTY). Since read and write operations can occur asynchronously to one another, special control circuitry is included to prevent metastability, overflow, and underflow. A block diagram of the memory module is illustrated in Figure 2-57.

During RAM operation, read (RA) and write (WA) addresses are sourced by user logic and the FIFO controller is ignored. In FIFO mode, the internal addresses are generated by the FIFO controller and routed to the RAM array by internal MUXes. Enables with programmable polarity are provided to create upper address bits for cascading up to 16 memory blocks. When cascading memory blocks, the bussed signals WA, WD, WEN, RA, RD, and REN are internally linked to eliminate external routing congestion.

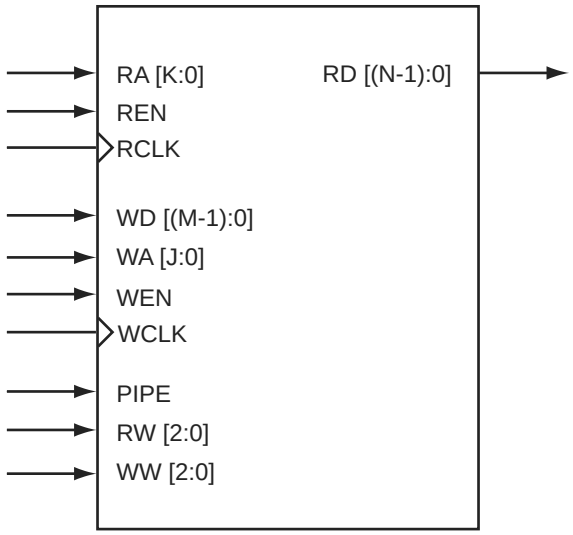


Figure 2-57 Axcelerator Memory Module

Table 2-100 Four FIFO Blocks Cascaded
Worst-Case Commercial Conditions VCCA = 1.425 V, VCCI = 3.0 V, T_J = 70°C

		2 Speed		1 Speed		Std Speed		
Parameter	Description	Min.	Max.	Min.	Max.	Min.	Max.	Units
FIFO Module Timing								
t_{WSU}	Write Setup		14.60		16.63		19.55	ns
t_{WHD}	Write Hold		0.00		0.00		0.00	ns
t_{WCKH}	WCLK High		0.75		0.75		0.75	ns
t_{WCKL}	WCLK Low		2.51		2.51		2.51	ns
t_{WCKP}	Minimum WCLK Period	3.26		3.26		3.26		ns
t_{RSU}	Read Setup		15.27		17.39		20.44	ns
t_{RHD}	Read Hold		0.00		0.00		0.00	ns
t_{RCKH}	RCLK High		0.73		0.73		0.73	ns
t_{RCKL}	RCLK Low		2.96		2.96		2.96	ns
t_{RCKP}	Minimum RCLK period	3.69		3.69		3.69		ns
t_{CLRHF}	Clear High		0.00		0.00		0.00	ns
t_{CLR2FF}	Clear-to-flag (EMPTY/FULL)		1.92		2.18		2.57	ns
t_{CLR2AF}	Clear-to-flag (AEMPTY/AFULL)		4.39		5.00		5.88	ns
t_{CK2FF}	Clock-to-flag (EMPTY/FULL)		2.13		2.42		2.85	ns
t_{CK2AF}	Clock-to-flag (AEMPTY/AFULL)		5.04		5.75		6.75	ns
$t_{RCK2RD1}$	RCLK-To-OUT (Pipelined)		2.36		2.69		3.16	ns
$t_{RCK2RD2}$	RCLK-To-OUT (Nonpipelined)		2.83		3.23		3.79	ns

Note: Timing data for these four cascaded FIFO blocks uses a depth of 16,384. For all other combinations, use Microsemi's timing software.

FG484	
AX500 Function	Pin Number
IO108PB5F10	AA10
IO110NB5F10	AB9
IO110PB5F10	AB10
IO111NB5F10	Y8
IO111PB5F10	Y9
IO112NB5F10	AB7
IO113NB5F10	W8
IO113PB5F10	W9
IO114NB5F11	AA7
IO114PB5F11	AA8
IO115NB5F11	AB5
IO115PB5F11	AB6
IO116NB5F11	Y6
IO116PB5F11	Y7
IO117NB5F11	U8
IO117PB5F11	U9
IO118NB5F11	AA5
IO118PB5F11	AA6
IO119NB5F11	AA4
IO119PB5F11	AB4
IO120NB5F11	Y4
IO120PB5F11	Y5
IO121NB5F11	W6
IO121PB5F11	W7
IO122NB5F11	V3
IO122PB5F11	W3
IO123NB5F11	T7
IO123PB5F11	T8
IO124NB5F11	V4
IO124PB5F11	W5
IO125NB5F11	V6
IO125PB5F11	V7
Bank 6	
IO126NB6F12	V2
IO126PB6F12	W2

FG484	
AX500 Function	Pin Number
IO127NB6F12	P7
IO127PB6F12	R7
IO128NB6F12	V1
IO128PB6F12	W1
IO129NB6F12	U5
IO129PB6F12	T5
IO130NB6F12	T1
IO130PB6F12	U1
IO131NB6F12	P6
IO131PB6F12	R6
IO132NB6F12	T4
IO132PB6F12	U4
IO133NB6F12	U2
IO134NB6F12	T3
IO134PB6F12	U3
IO135NB6F12	P5
IO135PB6F12	R5
IO136NB6F13	R2
IO136PB6F13	T2
IO138NB6F13	P4
IO138PB6F13	R4
IO139NB6F13	N2
IO139PB6F13	P2
IO140NB6F13	P3
IO140PB6F13	R3
IO141NB6F13	M6
IO141PB6F13	N6
IO142NB6F13	P1
IO142PB6F13	R1
IO143NB6F13	M5
IO143PB6F13	N5
IO144NB6F13	M4
IO144PB6F13	N4
IO145NB6F13	M7
IO145PB6F13	N7

FG484	
AX500 Function	Pin Number
IO146NB6F13	M3
IO146PB6F13	N3
Bank 7	
IO147NB7F14	K7
IO147PB7F14	L7
IO148NB7F14	M2
IO148PB7F14	N1
IO149NB7F14	K5
IO149PB7F14	L5
IO150NB7F14	L3
IO150PB7F14	L2
IO151NB7F14	K6
IO151PB7F14	L6
IO152NB7F14	K2
IO152PB7F14	K1
IO153NB7F14	K4
IO153PB7F14	K3
IO154NB7F14	H3
IO154PB7F14	J3
IO155NB7F14	H5
IO155PB7F14	J5
IO156NB7F14	H4
IO156PB7F14	J4
IO157NB7F14	H2
IO157PB7F14	J2
IO158NB7F15	H1
IO158PB7F15	J1
IO159NB7F15	F1
IO159PB7F15	G1
IO160NB7F15	F2
IO160PB7F15	G2
IO161NB7F15	H6
IO161PB7F15	J6
IO162NB7F15	F3
IO162PB7F15	G3

FG676	
AX1000 Function	Pin Number
Bank 0	
IO00NB0F0	B4
IO00PB0F0	C4
IO02NB0F0	E7
IO02PB0F0	E6
IO03NB0F0	D6
IO03PB0F0	D5
IO04NB0F0	B5
IO04PB0F0	C5
IO05NB0F0	A5
IO05PB0F0	A4
IO06NB0F0	F7
IO06PB0F0	F6
IO07NB0F0	B6
IO07PB0F0	C6
IO08NB0F0	C7
IO08PB0F0	D7
IO10NB0F0	F8
IO10PB0F0	E8
IO11NB0F0	A7
IO11PB0F0	A6
IO12NB0F1	C8
IO12PB0F1	D8
IO13NB0F1	B8
IO13PB0F1	B7
IO14NB0F1	D9
IO14PB0F1	E9
IO16NB0F1	F10
IO16PB0F1	F9
IO18NB0F1	B9
IO18PB0F1	C9
IO19NB0F1	A10
IO19PB0F1	A9
IO20NB0F1	D10
IO20PB0F1	E10
IO21NB0F1	B10

FG676	
AX1000 Function	Pin Number
IO21PB0F1	C10
IO22NB0F2	F11
IO22PB0F2	G11
IO24NB0F2	D11
IO24PB0F2	E11
IO26NB0F2	C12
IO26PB0F2	C11
IO28NB0F2	F12
IO28PB0F2	G12
IO30NB0F2/HCLKAN	A12
IO30PB0F2/HCLKAP	B12
IO31NB0F2/HCLKBN	C13
IO31PB0F2/HCLKBP	B13
Bank 1	
IO32NB1F3/HCLKCN	C15
IO32PB1F3/HCLKCP	C14
IO33NB1F3/HCLKDN	A15
IO33PB1F3/HCLKDP	B15
IO35NB1F3	B16
IO35PB1F3	A16
IO36NB1F3	F15
IO36PB1F3	G15
IO38NB1F3	F16
IO38PB1F3	G16
IO40NB1F3	A18
IO40PB1F3	A17
IO41NB1F4	C18
IO41PB1F4	C17
IO42NB1F4	D16
IO42PB1F4	E16
IO44NB1F4	D18
IO44PB1F4	D17
IO45NB1F4	B19
IO45PB1F4	B18
IO46NB1F4	B20
IO46PB1F4	A20

FG676	
AX1000 Function	Pin Number
IO48NB1F4	F17
IO48PB1F4	E17
IO49NB1F4	A22
IO49PB1F4	A21
IO50NB1F4	E18
IO50PB1F4	F18
IO51NB1F4	D19
IO51PB1F4	C19
IO52NB1F4	D20
IO52PB1F4	C20
IO54NB1F5	B22
IO54PB1F5	B21
IO55NB1F5	D21
IO55PB1F5	C21
IO56NB1F5	F19
IO56PB1F5	E19
IO57NB1F5	B23
IO57PB1F5	A23
IO58NB1F5	D22
IO58PB1F5	C22
IO59NB1F5	B24
IO59PB1F5	A24
IO60NB1F5	E21
IO60PB1F5	E20
IO62NB1F5	D23
IO62PB1F5	C23
IO63NB1F5	F21
IO63PB1F5	F20
Bank 2	
IO64NB2F6	H21
IO64PB2F6	G21
IO65NB2F6	G22
IO65PB2F6	F22
IO66NB2F6	F24
IO66PB2F6	F23
IO67NB2F6	E24

FG676	
AX1000 Function	Pin Number
IO129PB4F12	AA21
IO131NB4F12	AD22
IO131PB4F12	AD23
IO132NB4F12	AE23
IO132PB4F12	AE24
IO133NB4F12	AB20
IO133PB4F12	AA20
IO134NB4F12	AC21
IO134PB4F12	AC22
IO135NB4F12	AF22
IO135PB4F12	AF23
IO137NB4F12	AB19
IO137PB4F12	AA19
IO139NB4F13	AC19
IO139PB4F13	AC20
IO140NB4F13	AE21
IO140PB4F13	AE22
IO141NB4F13	AD20
IO141PB4F13	AD21
IO143NB4F13	AB17
IO143PB4F13	AB18
IO144NB4F13	AE19
IO144PB4F13	AE20
IO145NB4F13	AC17
IO145PB4F13	AC18
IO146NB4F13	AD18
IO146PB4F13	AD19
IO147NB4F13	AA17
IO147PB4F13	AA18
IO148NB4F13	AF20
IO148PB4F13	AF21
IO149NB4F13	AA16
IO149PB4F13	Y16
IO151NB4F13	AC16
IO151PB4F13	AB16
IO153NB4F14	AE17

FG676	
AX1000 Function	Pin Number
IO153PB4F14	AE18
IO154NB4F14	AF17
IO154PB4F14	AF18
IO155NB4F14	AA15
IO155PB4F14	Y15
IO157NB4F14	AC15
IO157PB4F14	AB15
IO159NB4F14/CLKEN	AE16
IO159PB4F14/CLKEP	AF16
IO160NB4F14/CLKFN	AE14
IO160PB4F14/CLKFP	AE15
Bank 5	
IO161NB5F15/CLKGN	AE12
IO161PB5F15/CLKGP	AE13
IO162NB5F15/CLKHN	AE11
IO162PB5F15/CLKHP	AF11
IO163NB5F15	AC12
IO163PB5F15	AB12
IO165NB5F15	Y12
IO165PB5F15	AA13
IO167NB5F15	Y11
IO167PB5F15	AA12
IO168NB5F15	AF9
IO168PB5F15	AF10
IO169NB5F15	AB11
IO169PB5F15	AA11
IO171NB5F16	AE9
IO171PB5F16	AE10
IO173NB5F16	AC10
IO173PB5F16	AC11
IO174NB5F16	AE7
IO174PB5F16	AE8
IO175NB5F16	AC9
IO175PB5F16	AD9
IO176NB5F16	AF6
IO176PB5F16	AF7

FG676	
AX1000 Function	Pin Number
IO177NB5F16	AA10
IO177PB5F16	AB10
IO179NB5F16	AD7
IO179PB5F16	AD8
IO180NB5F16	AC7
IO180PB5F16	AC8
IO181NB5F17	AA9
IO181PB5F17	AB9
IO183NB5F17	AD6
IO183PB5F17	AE6
IO184NB5F17	AE5
IO184PB5F17	AF5
IO185NB5F17	AA8
IO185PB5F17	AB8
IO187NB5F17	AC5
IO187PB5F17	AC6
IO188NB5F17	AD4
IO188PB5F17	AD5
IO189NB5F17	AB6
IO189PB5F17	AB7
IO190NB5F17	AF4
IO190PB5F17	AE4
IO191NB5F17	AE3
IO191PB5F17	AF3
IO192NB5F17	AA6
IO192PB5F17	AA7
Bank 6	
IO193NB6F18	Y5
IO193PB6F18	AA5
IO194NB6F18	AB3
IO194PB6F18	AC3
IO195NB6F18	Y4
IO195PB6F18	AA4
IO196NB6F18	AC2
IO196PB6F18	AD2
IO197NB6F18	W6

FG676	
AX1000 Function	Pin Number
IO197PB6F18	Y6
IO198NB6F18	AD1
IO198PB6F18	AE1
IO199NB6F18	AA2
IO199PB6F18	AB2
IO200NB6F18	Y3
IO200PB6F18	AA3
IO201NB6F18	V5
IO201PB6F18	W5
IO202NB6F18	AB1
IO202PB6F18	AC1
IO203NB6F19	V4
IO203PB6F19	W4
IO204NB6F19	V3
IO204PB6F19	W3
IO205NB6F19	U6
IO205PB6F19	V6
IO206NB6F19	W2
IO206PB6F19	Y2
IO207NB6F19	U4
IO207PB6F19	U5
IO208NB6F19	Y1
IO208PB6F19	AA1
IO209NB6F19	T6
IO209PB6F19	T7
IO211NB6F19	T3
IO211PB6F19	U3
IO212NB6F19	V1
IO212PB6F19	V2
IO213NB6F19	T5
IO213PB6F19	T4
IO214NB6F20	U1
IO214PB6F20	U2
IO215NB6F20	R6
IO215PB6F20	R7
IO217NB6F20	R5

FG676	
AX1000 Function	Pin Number
IO217PB6F20	R4
IO218NB6F20	R2
IO218PB6F20	T2
IO219NB6F20	P3
IO219PB6F20	R3
IO220NB6F20	R1
IO220PB6F20	T1
IO221NB6F20	P6
IO221PB6F20	P7
IO223NB6F20	P5
IO223PB6F20	P4
Bank 7	
IO225NB7F21	N5
IO225PB7F21	N4
IO226NB7F21	N2
IO226PB7F21	N3
IO227NB7F21	N6
IO227PB7F21	N7
IO229NB7F21	M7
IO229PB7F21	M6
IO231NB7F21	M5
IO231PB7F21	M4
IO232NB7F21	L1
IO232PB7F21	M1
IO233NB7F21	M2
IO233PB7F21	M3
IO235NB7F21	K2
IO235PB7F21	L2
IO236NB7F22	L5
IO236PB7F22	L4
IO237NB7F22	L6
IO237PB7F22	L7
IO238NB7F22	K3
IO238PB7F22	L3
IO240NB7F22	J1
IO240PB7F22	K1

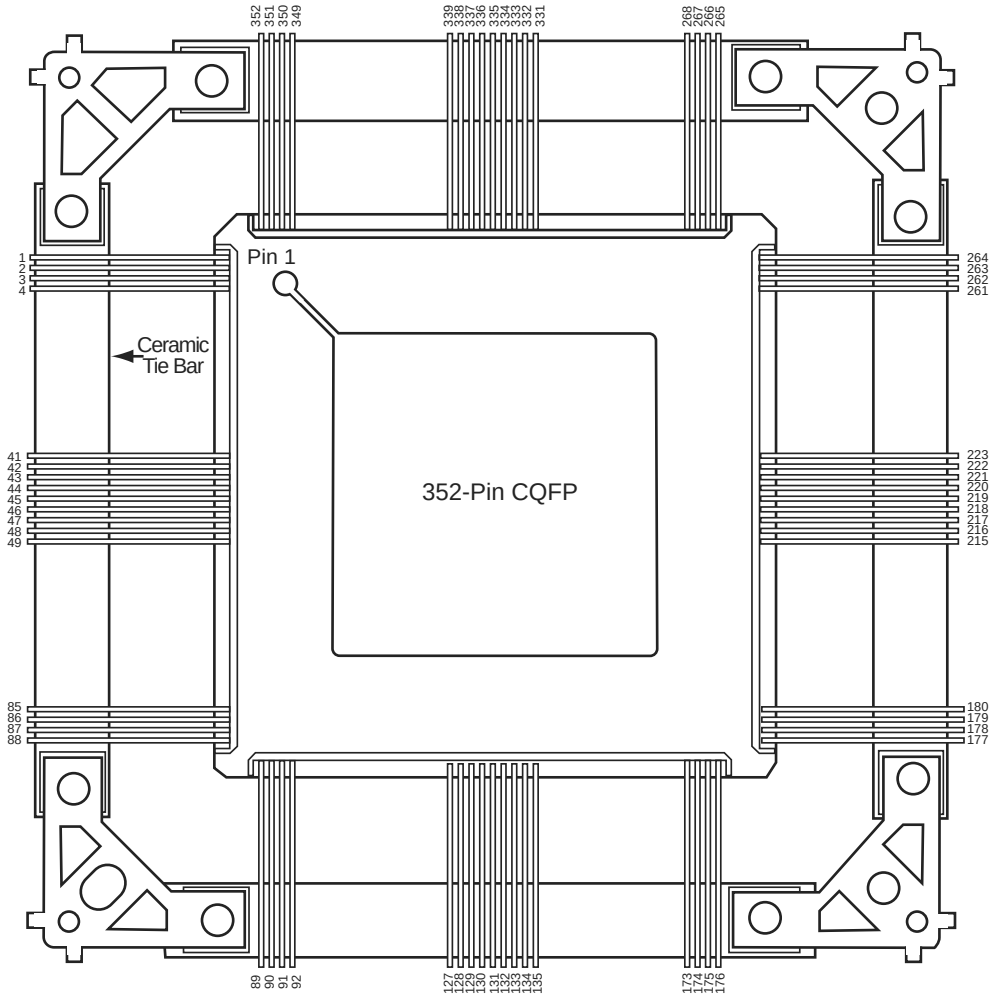
FG676	
AX1000 Function	Pin Number
IO241NB7F22	K6
IO241PB7F22	K5
IO242NB7F22	H2
IO242PB7F22	J2
IO243NB7F22	J4
IO243PB7F22	K4
IO244NB7F22	H3
IO244PB7F22	J3
IO245NB7F22	G2
IO245PB7F22	G1
IO247NB7F23	J6
IO247PB7F23	J5
IO248NB7F23	E1
IO248PB7F23	F1
IO249NB7F23	E2
IO249PB7F23	F2
IO250NB7F23	G4
IO250PB7F23	H4
IO251NB7F23	F3
IO251PB7F23	G3
IO253NB7F23	H6
IO253PB7F23	H5
IO254NB7F23	D2
IO254PB7F23	D1
IO255NB7F23	E4
IO255PB7F23	F4
IO256NB7F23	D3
IO256PB7F23	E3
IO257NB7F23	F5
IO257PB7F23	G5
Dedicated I/O	
GND	A1
GND	A13
GND	A14
GND	A19
GND	A26

FG896	
AX1000 Function	Pin Number
GND	A13
GND	A18
GND	A2
GND	A23
GND	A29
GND	A8
GND	AA10
GND	AA21
GND	AA28
GND	AA3
GND	AB2
GND	AB22
GND	AB29
GND	AB9
GND	AC1
GND	AC30
GND	AE25
GND	AE6
GND	AF26
GND	AF5
GND	AG27
GND	AG4
GND	AH10
GND	AH15
GND	AH16
GND	AH21
GND	AH28
GND	AH3
GND	AJ1
GND	AJ2
GND	AJ22
GND	AJ29
GND	AJ30
GND	AJ9
GND	AK13

FG896	
AX1000 Function	Pin Number
GND	AK18
GND	AK2
GND	AK23
GND	AK29
GND	AK8
GND	B1
GND	B2
GND	B22
GND	B29
GND	B30
GND	B9
GND	C10
GND	C15
GND	C16
GND	C21
GND	C28
GND	C3
GND	D27
GND	D28
GND	D4
GND	E26
GND	E5
GND	H1
GND	H30
GND	J2
GND	J22
GND	J29
GND	J9
GND	K10
GND	K21
GND	K28
GND	K3
GND	L11
GND	L20
GND	M12

FG896	
AX1000 Function	Pin Number
GND	M13
GND	M14
GND	M15
GND	M16
GND	M17
GND	M18
GND	M19
GND	N1
GND	N12
GND	N13
GND	N14
GND	N15
GND	N16
GND	N17
GND	N18
GND	N19
GND	N30
GND	P12
GND	P13
GND	P14
GND	P15
GND	P16
GND	P17
GND	P18
GND	P19
GND	R12
GND	R13
GND	R14
GND	R15
GND	R16
GND	R17
GND	R18
GND	R19
GND	R28
GND	R3

CQ352



Note

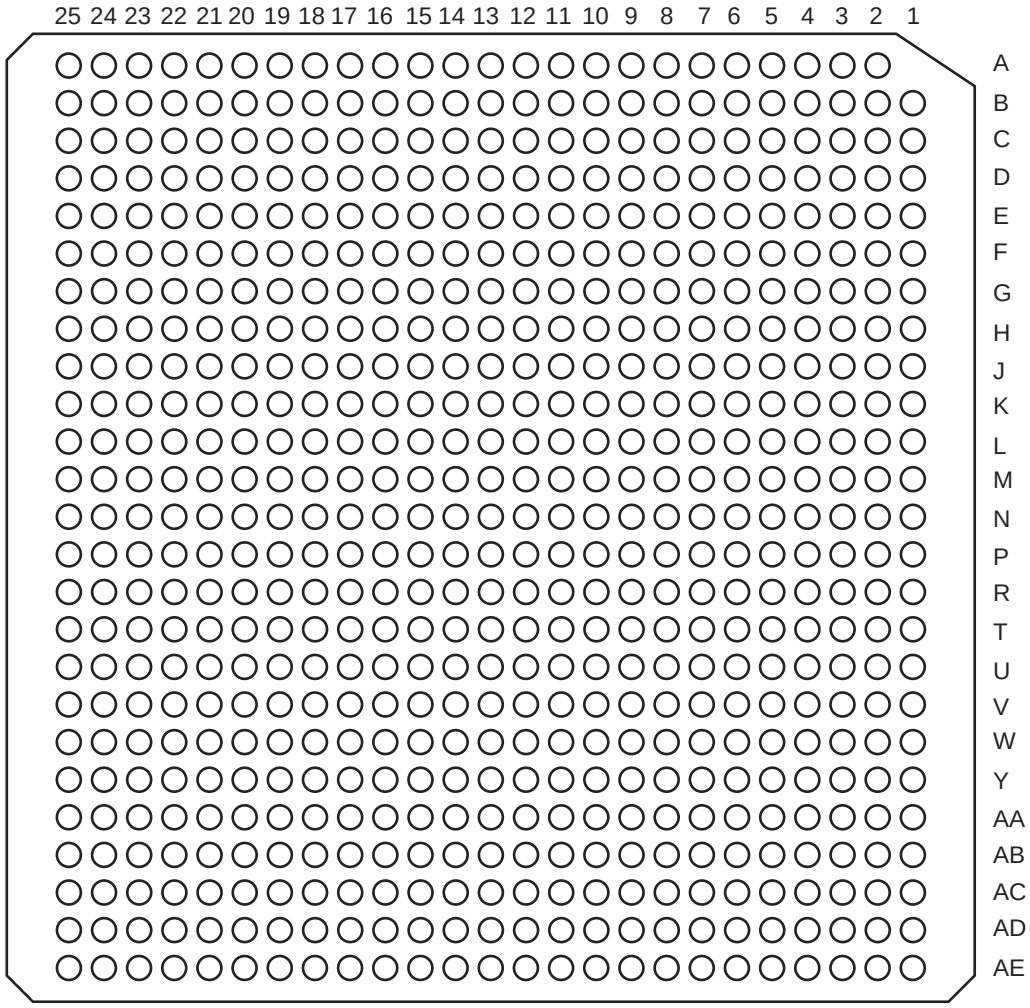
For Package Manufacturing and Environmental information, visit Resource center at http://www.microsemi.com/soc/products/rescenter/package/index.html.

CQ352	
AX2000 Function	Pin Number
IO182PB4F17	171
IO183NB4F17	166
IO183PB4F17	167
IO184NB4F17	164
IO184PB4F17	165
IO185NB4F17	160
IO185PB4F17	161
IO190NB4F17	158
IO190PB4F17	159
IO191NB4F17	154
IO191PB4F17	155
IO192NB4F17	152
IO192PB4F17	153
IO207NB4F19	146
IO207PB4F19	147
IO212NB4F19/CLKEN	142
IO212PB4F19/CLKEP	143
IO213NB4F19/CLKFN	136
IO213PB4F19/CLKFP	137
Bank 5	
IO214NB5F20/CLKGN	128
IO214PB5F20/CLKGP	129
IO215NB5F20/CLKHN	122
IO215PB5F20/CLKHP	123
IO217NB5F20	118
IO217PB5F20	119
IO236NB5F22	110
IO236PB5F22	111
IO237NB5F22	112
IO237PB5F22	113
IO238NB5F22	104
IO238PB5F22	105
IO239NB5F22	106
IO239PB5F22	107
IO240NB5F22	100

CQ352	
AX2000 Function	Pin Number
IO240PB5F22	101
IO242NB5F22	94
IO242PB5F22	95
IO243NB5F22	98
IO243PB5F22	99
IO244NB5F22	92
IO244PB5F22	93
Bank 6	
IO257PB6F24	86
IO258NB6F24	84
IO258PB6F24	85
IO261NB6F24	82
IO261PB6F24	83
IO262NB6F24	78
IO262PB6F24	79
IO265NB6F24	76
IO265PB6F24	77
IO279NB6F26	72
IO279PB6F26	73
IO280NB6F26	70
IO280PB6F26	71
IO281NB6F26	66
IO281PB6F26	67
IO282NB6F26	64
IO282PB6F26	65
IO284NB6F26	60
IO284PB6F26	61
IO285NB6F26	58
IO285PB6F26	59
IO286NB6F26	54
IO286PB6F26	55
IO287NB6F26	52
IO287PB6F26	53
IO294NB6F27	48
IO294PB6F27	49

CQ352	
AX2000 Function	Pin Number
IO296NB6F27	46
IO296PB6F27	47
Bank 7	
IO300NB7F28	42
IO300PB7F28	43
IO303NB7F28	40
IO303PB7F28	41
IO310NB7F29	34
IO310PB7F29	35
IO311NB7F29	36
IO311PB7F29	37
IO312NB7F29	28
IO312PB7F29	29
IO315NB7F29	30
IO315PB7F29	31
IO316NB7F29	22
IO316PB7F29	23
IO317NB7F29	24
IO317PB7F29	25
IO318NB7F29	18
IO318PB7F29	19
IO320NB7F29	16
IO320PB7F29	17
IO334NB7F31	10
IO334PB7F31	11
IO335NB7F31	12
IO335PB7F31	13
IO338NB7F31	6
IO338PB7F31	7
IO341NB7F31	4
IO341PB7F31	5
Dedicated I/O	
GND	1
GND	9
GND	15

CG624



Note

For Package Manufacturing and Environmental information, visit Resource center at http://www.microsemi.com/soc/products/rescenter/package/index.html.

CG624	
AX2000 Function	Pin Number
Bank 0	
IO00NB0F0	D7*
IO00PB0F0	E7*
IO01NB0F0	G7
IO01PB0F0	G6
IO02NB0F0	B5
IO02PB0F0	B4
IO04PB0F0	C7
IO05NB0F0	F8
IO05PB0F0	F7
IO06NB0F0	H8
IO06PB0F0	H7
IO11NB0F0	J8
IO11PB0F0	J7
IO12PB0F1	B6
IO13NB0F1	E9*
IO13PB0F1	D8*
IO15NB0F1	C9
IO15PB0F1	C8
IO16NB0F1	A5
IO16PB0F1	A4
IO17NB0F1	D10
IO17PB0F1	D9
IO18NB0F1	A7
IO18PB0F1	A6
IO19NB0F1	G9
IO19PB0F1	G8
IO20PB0F1	B7
IO23NB0F2	F10
IO23PB0F2	F9
IO26NB0F2	C11*
IO26PB0F2	B8*

Note: *Not routed on the same package layer and to adjacent LGA pads as its differential pair complement. Recommended to be used as a single-ended I/O.

CG624	
AX2000 Function	Pin Number
IO27NB0F2	H10
IO27PB0F2	H9
IO28NB0F2	A9
IO28PB0F2	B9
IO30NB0F2	B11
IO30PB0F2	B10
IO31NB0F2	E11
IO31PB0F2	F11
IO33NB0F2	D12
IO33PB0F2	D11
IO34NB0F3	A11
IO34PB0F3	A10
IO37NB0F3	J13
IO37PB0F3	K13
IO38NB0F3	H11
IO38PB0F3	G11
IO40PB0F3	B12
IO41NB0F3/HCLKAN	G13
IO41PB0F3/HCLKAP	G12
IO42NB0F3/HCLKBN	C13
IO42PB0F3/HCLKBP	C12
Bank 1	
IO43NB1F4/HCLKCN	G15
IO43PB1F4/HCLKCP	G14
IO44NB1F4/HCLKDN	B14
IO44PB1F4/HCLKDP	B13
IO45NB1F4	H13
IO47NB1F4	D14
IO47PB1F4	C14
IO48NB1F4	A16
IO48PB1F4	A15
IO49PB1F4	H15

Note: *Not routed on the same package layer and to adjacent LGA pads as its differential pair complement. Recommended to be used as a single-ended I/O.

CG624	
AX2000 Function	Pin Number
IO51NB1F4	E15
IO51PB1F4	F15
IO52NB1F4	A17
IO55NB1F5	G16
IO55PB1F5	H16
IO56NB1F5	A20
IO56PB1F5	A19
IO57NB1F5	D16
IO57PB1F5	D15
IO58NB1F5	A22
IO58PB1F5	A21
IO59NB1F5	F16
IO61NB1F5	G17
IO61PB1F5	H17
IO62NB1F5	B17
IO62PB1F5	B16
IO63NB1F5	H18
IO65NB1F6	C17
IO66PB1F6	B18
IO67NB1F6	J18
IO67PB1F6	J19
IO68NB1F6	B20
IO68PB1F6	B19
IO69NB1F6	E17
IO69PB1F6	F17
IO70NB1F6	B22
IO70PB1F6	B21
IO71PB1F6	G18
IO73NB1F6	G19
IO74NB1F6	C19
IO74PB1F6	C18
IO75NB1F6	D18

Note: *Not routed on the same package layer and to adjacent LGA pads as its differential pair complement. Recommended to be used as a single-ended I/O.

CG624	
AX2000 Function	Pin Number
IO75PB1F6	D17
IO76NB1F7	C21
IO76PB1F7	C20
IO79NB1F7	H20
IO79PB1F7	H19
IO80NB1F7	E18
IO80PB1F7	F18
IO81NB1F7	G21
IO81PB1F7	G20
IO82NB1F7	F20
IO82PB1F7	F19
IO85NB1F7	D20*
IO85PB1F7	D19*
Bank 2	
IO86NB2F8	F23
IO86PB2F8	E23
IO87NB2F8	H23
IO87PB2F8	G23
IO88NB2F8	E24
IO88PB2F8	D24
IO89NB2F8	M17*
IO89PB2F8	G22*
IO91NB2F8	J22
IO91PB2F8	H22
IO92NB2F8	L18
IO92PB2F8	K18
IO96NB2F9	G24
IO96PB2F9	F24
IO97NB2F9	J21
IO97PB2F9	J20
IO98PB2F9	J23
IO99NB2F9	L19

Note: *Not routed on the same package layer and to adjacent LGA pads as its differential pair complement. Recommended to be used as a single-ended I/O.

CG624	
AX2000 Function	Pin Number
IO99PB2F9	K19
IO100NB2F9	E25
IO100PB2F9	D25
IO103PB2F9	K20
IO105NB2F9	M19
IO105PB2F9	M18
IO106NB2F9	J24
IO106PB2F9	H24
IO107NB2F10	L23*
IO107PB2F10	N16*
IO109NB2F10	L22
IO109PB2F10	K22
IO110NB2F10	G25
IO110PB2F10	F25
IO111NB2F10	L21
IO111PB2F10	L20
IO112NB2F10	L24
IO112PB2F10	K24
IO113NB2F10	N17
IO115NB2F10	M20
IO115PB2F10	M21
IO117NB2F10	N19
IO117PB2F10	N18
IO118NB2F11	J25
IO121NB2F11	N24
IO121PB2F11	M24
IO122NB2F11	L25
IO122PB2F11	K25
IO123NB2F11	N22
IO123PB2F11	M22
IO124NB2F11	N23
IO124PB2F11	M23

Note: *Not routed on the same package layer and to adjacent LGA pads as its differential pair complement. Recommended to be used as a single-ended I/O.

CG624	
AX2000 Function	Pin Number
IO127NB2F11	P18
IO127PB2F11	P17
IO128NB2F11	N25
IO128PB2F11	M25
Bank 3	
IO129NB3F12	N20
IO130PB3F12	P24
IO131NB3F12	P21
IO133NB3F12	P20
IO133PB3F12	P19
IO138NB3F12	R23
IO138PB3F12	P23
IO139NB3F13	R22
IO139PB3F13	P22
IO141NB3F13	R19
IO142NB3F13	R25
IO142PB3F13	P25
IO143PB3F13	R21
IO145NB3F13	T18
IO145PB3F13	R18
IO146NB3F13	T24
IO146PB3F13	R24
IO147NB3F13	T20
IO147PB3F13	R20
IO148NB3F13	U25
IO148PB3F13	T25
IO149NB3F13	T22
IO153NB3F14	U19
IO153PB3F14	T19
IO154NB3F14	Y25
IO154PB3F14	W25
IO157NB3F14	V20

Note: *Not routed on the same package layer and to adjacent LGA pads as its differential pair complement. Recommended to be used as a single-ended I/O.

4 Datasheet Information

List of Changes

The following table lists critical changes that were made in the current version of the document.

Revision	Changes	Page
Revision 18 (March 2012)	Table 2-1 Absolute Maximum Ratings was updated to correct the maximum DC core supply voltage (VCCA) from 1.6 V to 1.7 V (SAR 36786). The maximum input voltage (VI) was corrected from 3.75 V to 4.1 V (SAR 35419).	2-1
	Values for tristate leakage current IOZ, and IIH and IIL were added to Table 2-3 Standby Current (SARs 35774, 32021).	2-2
	Figure 2-2 VCCPLX and VCOMPLX Power Supply Connect was updated to correct the units for the resistance from "W" to : (SAR 36415).	2-9
	In the Introduction to the "User I/Os" section, the following sentence was added to clarify the slew rate setting (SAR 34943): The slew rate setting is effective for both rising and falling edges.	2-11
	Figure 2-3 Use of an External Resistor for 5 V Tolerance was revised to show the VCCI and GND clamp diodes. The explanatory text above the figure was revised as well (SAR 34942).	2-13
	EQ 3 for 5 V tolerance was corrected to change Vdiode from 0.6 V to 0.7 V (SAR 36786).	2-13
	Additional information was added to the "Using the Weak Pull-Up and Pull-Down Circuits" section to clarify how the weak pull-up and pull-down resistors are physically implemented (SAR 34945).	2-17
	The description for the C_{INCLK} parameter in Table 2-18 Input Capacitance was changed from "Input capacitance on clock pin" to "Input capacitance on HCLK and RCLK pin" (SAR 34944).	2-21
	Table 2-19 I/O Input Rise Time and Fall Time* is new (SAR 34942).	2-21
	The minimum VIL for 1.5 V LVCMOS and PCI was corrected from 0.5 to 0.3 in Table 2-29 DC Input and Output Levels and Table 2-33 DC Input and Output Levels (SAR 34358).	2-38, 2-40
	Support for simulating the GCLR/ GPSET feature in the Axcelerator Family was added in Libero software v9.0 SPI1. Reference to the section explaining this in the Antifuse Macro Library Guide was added to the "R-Cell" section (SAR 26413).	2-58
	The enable signal in Figure 2-32 R-Cell Delays was corrected to show it is active low rather than active high (SAR 34946).	2-59
Revision 17 (September 2011)	The versioning system for datasheets has been changed. Datasheets are assigned a revision number that increments each time the datasheet is revised. The "Axcelerator Family Device Status" table indicates the status for each device in the device family.	iii
	The "Features" section, "Programmable Interconnect Element" section, and "Security" section were revised to clarify that although no existing security measures can give an absolute guarantee, Microsemi FPGAs implement the best security available in the industry (SAR 32865).	i, 1-1, 2-108